

Withdrawal of Claims 66-67

The Examiner withdrew claims 66-67 as allegedly being directed to a non-elected invention.

Applicants respectfully contend that claims 66 and 67 fall within the scope of elected claim 28. In particular, claim 28 recites: "a complex power-signal (CPS) substructure that has passed an electrical performance acceptance test for at least one of an electrical integrity and electrical signal delay, wherein the test for electrical integrity includes a test for at least one of an electrical short, an electrical open, and an erroneous impedance" (emphasis added).

Claim 66 recites: "wherein the CPS substructure has passed an electrical performance acceptance test for electrical signal delay" (emphasis added). Accordingly, claim 66 tracks the exact language of elected claim 28 and merely expresses a limitation that is within the scope and exact language of elected claim 28. Therefore, Applicants respectfully contend that claim 66 falls within the scope and exact language of elected claim 28 and is not directed to a non-elected invention.

Claim 67 recites: "wherein the CPS substructure has passed an electrical performance acceptance test for electrical integrity, and wherein the test for electrical integrity includes a test for an erroneous impedance" (emphasis added). Accordingly, claim 67 tracks the exact language of elected claim 28 and merely expresses a limitation that is within the scope and exact language of elected claim 28. Therefore, Applicants respectfully contend that claim 67 falls within the scope and exact language of elected claim 28 and is not directed to a non-elected

invention.

Based on the preceding arguments, Applicants respectfully request removal of the "withdrawn" status of claims 66-67 and that claims 66-67 be rejoined and examined.

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**35 U.S.C. §103(a): Claims 28-31, 33, 35-41, 51-54, 56, and 58-64**

The Examiner rejected claims 28-31, 33, 35-41, 51-54, 56, and 58-64 under 35 U.S.C. §103(a) as allegedly being unpatentable over DiStefano et al. (US 5,558,928) in view of Noddin et al. (US 5,276,955).

Applicants respectfully contend that claims 28 and 51 are not unpatentable over DiStefano in view of Noddin, because DiStefano in view of Noddin does not teach or suggest each and every feature of claims 28 and 51. For example, DiStefano in view of Noddin does not teach or suggest the following features of claim 28: "a complex power-signal (CPS) substructure that has passed an electrical performance acceptance test for at least one of an electrical integrity and electrical signal delay, wherein the test for electrical integrity includes a test for at least one of an electrical short, an electrical open, and an erroneous impedance" and "a first multilevel conductive via through the DM laminate, wherein the first multilevel conductive via is electrically coupled to a first metal layer of the CPS substructure." Similarly, DiStefano in view of Noddin does not teach or suggest the following features of claim 51: "a complex power-signal (CPS) substructure" and "a first multilevel conductive via through the DM laminate, wherein the first multilevel conductive via is electrically coupled to a first metal layer of the CPS substructure".

Applicants respectfully contend that DiStefano does not teach or suggest a CPS substructure, which the Examiner has acknowledged. The Examiner argues that DiStefano discloses a DM laminate 10b and that "Noddin discloses 14 and 16 are complex power-signal and they are connected a conductor via as shown in Fig. 6 to conductive structures mounted to 18. It would have been obvious to one of ordinary skill in the art at the time the invention was

made to modify DiStefano by the substructure is a complex power-signal and the first metal layer is a complex power-signal, as taught by Noddin, for the purpose of providing complex power-signal to an electronic component mounted on the interposer".

Applicants view the preceding argument by the Examiner to be ambiguous because that language of the argument is unclear and incomprehensible. The phrase "Noddin discloses 14 and 16 are complex power-signal" makes no sense. The phrase "is a complex power-signal and the first metal layer is a complex power-signal" has no subject and makes no sense. For the purpose of analyzing the Examiner's arguments, Applicants are assuming that the Examiner considers Noddin to disclose a CPS substructure comprising power layer 14 and signal pair layer 16. Applicants are further assuming that the Examiner is arguing modifying DiStefano for the purpose of providing a "complex power-signal" to an electronic component mounted on the interposer. However, Applicants do not know what the Examiner means by "complex power-signal" and is therefore interpreting "complex power-signal" to mean an electrical signal.

Applicants respectfully contend that the Examiner's argument for modifying DiStefano by Noddin's CPS substructure is not persuasive. The Examiner's argument of "providing complex power-signal to an electronic component mounted to the interposer" is not persuasive, because all circuit panels in DiStefano's configuration of FIG. 2 are conductively coupled (by conductive plated vias 26 and conductive elements 48) to the top end or bottom end of the configuration (e.g., in FIG. 1, the top end of the configuration is surface 16 of panel 10a and the bottom end of the configuration is surface 18 of circuit panel 10c). Thus, any electrical signal may be passed into the DiStefano's configuration at either the top or bottom end and received at any circuit panel within the configuration without attaching Noddin's CPS substructure to panel

10b of DiStefano. Furthermore, if DiStefano does not already have a mechanism to pass an electrical signal to any of the panels, then DiStefano's invention would not be enabled. Therefore, the Examiner's argument of modifying DiStefano to in order to provide a signal is not persuasive.

Applicants next present an independent analysis to demonstrate that it is not obvious to modify DiStefano by Noddin. If DiStefano discloses a DM laminate 10b as alleged by the Examiner and if Noddin discloses a CPS substructure, then Applicants assert that said CPS substructure from Noddin can only be combined with the DM laminate 10b of DiStefano if the CPS substructure is placed adjacent to the panel 10b as required by claims 28 and 51. Claims 28 and 51 recite: "a first dielectric layer of the N dielectric layers is formed on a first external surface of the CPS substructure"). However, panel 10b is sandwiched between interposers 12a and 12c (see FIG. 1 of DiStefano). Therefore, the placement of the CPS substructure adjacent to the panel 10b would disturb the alternating pattern of circuit panels 10 and interposers 12 and thus destroy the DiStefano invention. In particular, DiStefano discloses in col. 4, line 57 - col. 5, line 9:

**"A method according to this aspect of the invention preferably includes the step of stacking the circuit panels and interposers in superposed relation so that each interposer is disposed between two circuit panels, with the major surfaces of the interposers and circuit panels confronting one another, and with interconnect locations on the confronting surfaces of the circuit panels and interposers being aligned with one another. The method most preferably further includes the step of**

causing the flowable dielectric material to flow and conform to the major surfaces of the circuit panels. The method desirably includes the step of causing the flowable dielectric material to flow and conform to the major surfaces of the circuit panels and on the interposers into continuous electrical conductors extending between adjacent circuit boards at their respective interconnect locations. Most preferably, the flowable dielectric and flowable conductive materials are caused to flow concomitantly with one another in a single step involving application of heat and pressure to the stacked circuit panels and interposers" (emphasis added).

Applicants contend that the preceding quote from DiStefano makes it clear that the alternating pattern of circuit panels and interposers is an essential aspect of the DiStefano invention and cannot be modified. For example, it is critical in DiStefano that "each interposer is disposed between two circuit panels, with the major surfaces of the interposers and circuit panels confronting one another" so that the flowable dielectric material will flow and conform to the major surfaces of the circuit panels, and so that the flowable dielectric material flows and conforms to the major surfaces of the circuit panels. This principle underlying the DiStefano invention is repeated throughout the DiStefano disclosure and in the DiStefano claims. For example, see claim 1 of DiStefano. Thus, Applicants maintain that to add a CPS substructure within the structural configuration of DiStefano adjacent to the DM laminate 10b will disable the preceding relationship between the circuit panels and the interposers such that the DiStefano invention will be effectively destroyed.

Applicants also note that DiStefano in view of Noddin does not teach or suggest the following feature of claim 28: "a complex power-signal (CPS) substructure that has passed an electrical performance acceptance test". The Examiner's argument that "DiStefano discloses testing the substructures" is not persuasive, since claim 28 requires testing a CPS substructure and DiStefano does not teach or suggest a CPS substructure as admitted by the Examiner. DiStefano discloses testing only circuit panels and interposers.

Based on the preceding arguments, Applicants respectfully maintain that claims 28 and 51 are not unpatentable over DiStefano in view of Noddin, and that claims 28 and 51 are in condition for allowance. Since claims 29-31, 33, 35-41, and 63-64 depend from claim 28, Applicants contend that claims 29-31, 33, 35-41, and 63-64 are likewise in condition for allowance. Since claims 52-54, 56 and 58-62 depend from claim 51, Applicants contend that claims 52-54, 56 and 58-62 are likewise in condition for allowance.

Applicants note that many of the dependent claims have an independent basis for patentability. For example, claims 29 and 52 recite: "wherein the first multilevel conductive via is a stacked via". The Examiner's allegation that via 26b in FIG. 2 of DiStefano is a stacked via is incorrect, because a stacked via is characterized by "discontinuities in sidewall smoothness at layer interfaces", which is not satisfied by via 26b in FIG. 2 of DiStefano. See Applicants' specification, page 8, lines 19-21. In "Response to Arguments", the Examiner incorrectly views said discontinuities as limitations which cannot be read into the claims. Applicants maintain, however, that a "stacked via" includes said discontinuities as a matter of definition and not as a

matter of limitation. Applicants carefully defined a variety of different types of vias in the specification and these definitions are read into the claims because they are definitions rather than limitations. In the specification, the term "via" has special cases of simple via, stacked via, deep via, etc., all of which are carefully defined in the specification and such definitions apply to the claims.

As another example, claims 38 and 61 recite: "a conducting via beginning at the first external surface of the CPS substructure and extending through a fraction of a total thickness of the CPS substructure", and claims 39-41 and 62-64 recite limitations on said "fraction".

Applicants contend that the Examiner's arguments relating to vias 26, 26b, and 26c are irrelevant, since vias 26, 26b, and 26c are not vias of a CPS structure as required by claims 38-41 and 61-64.



**35 U.S.C. §103(a): Claims 42-44**

The Examiner rejected claims 42-44 under 35 U.S.C. §103(a) as allegedly being unpatentable over DiStefano et al. (US 5,558,928) in view of Noddin et al. (US 5,276,955).

Applicants respectfully contend that claim 42 is not unpatentable over DiStefano in view of Noddin, because DiStefano in view of Noddin does not teach or suggest each and every feature of claim 42. For example, DiStefano in view of Noddin does not teach or suggest the following features of claim 42: "a complex power-signal (CPS) substructure that has satisfied an electrical performance acceptance test for at least one of an electrical integrity and electrical signal delay, and wherein the test for electrical integrity includes a test for at least one of an electrical short, an electrical open, and an erroneous impedance, a first dielectric-metallic (DM) laminate that includes an alternating sequence of an equal number N of dielectric layers and metallic layers such that a first dielectric layer of the N dielectric layers is formed on a first external surface of the CPS substructure, wherein N is at least 2, and wherein a first multilevel conductive via through the first DM laminate is electrically coupled to a first metal layer of the CPS substructure", based on the same reasons presented *supra* in conjunction with claim 28.

In addition, DiStefano in view of Noddin does not teach or suggest "a second dielectric-metallic (DM) laminate that includes an alternating sequence of an equal number M of dielectric layers and metallic layers such that a first dielectric layer of the M dielectric layers is formed on a second external surface of the CPS substructure, wherein M is at least 2, and wherein a second multilevel conductive via through the second DM laminate is electrically coupled to a second metal layer of the CPS substructure".

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The Examiner argues: "DiStefano/Noddin fail to disclose providing another DM laminate to the opposite side of the CPS substructure. It would have been obvious to one having ordinary skill in the art at the time the invention was made to provide another DM laminate, since it has been held that mere duplication of the essential working parts of a device involves only routine skill in the art. *St. Regis Paper Co. v. Bemis Co.*, 193 USPQ 8. Further, it would have been obvious to one having ordinary skill in the art at the time the invention was made to position another DM laminate to the opposite side of the CPS substructure, since it has been held that rearranging parts of an invention involves only routine skill in the art. *In re Japikse*, 86 USPQ 70."

Applicants respectfully contend that the preceding argument by the Examiner is not legally persuasive, because the Examiner has inaccurately stated the holdings in *St. Regis Paper* and *In re Japikse*. In addition, the Examiner has not applied *St. Regis Paper* and *In re Japikse* to the pertinent aspects of claim 42 in accordance with acceptable standards of legal analysis. In the absence of credible legal analysis by the Examiner, the preceding argument by the Examiner is not legally persuasive. Applicants respectfully maintain that "it has been held that rearranging parts of an invention involves only routine skill in the art" is not a credible argument. Accordingly, Applicants respectfully contend that the Examiner has not established a *prima facie* case of obviousness in relation to claim 42.

In addition, "to position another DM laminate to the opposite side of the CPS substructure", as argued by the Examiner, would disturb the relationship between the circuit panels and the interposers so as to destroy the DiStefano invention, as explained *supra*.

Based on the preceding arguments, Applicants respectfully maintain that claim 42 is not

unpatentable over DiStefano in view of Noddin, and that claim 42 is in condition for allowance. Since claims 43-44 depend from claim 42, Applicants contend that claims 43-44 are likewise in condition for allowance.

Applicants reiterate that the Examiner has not presented any argument relating to claim 43. Accordingly, Applicants respectfully contend that the Examiner has failed to establish a *prima facie* case for obviousness in relation to claim 43.

**35 U.S.C. §103(a): Claim 49**

The Examiner rejected claim 49 under 35 U.S.C. §103(a) as allegedly being unpatentable over DiStefano et al. (US 5,558,928) in view of Noddin et al. (US 5,276,955), and further in view of Koontz et al. (US 6,181,004).

Applicants respectfully contend that claim 49 is not unpatentable over DiStefano in view of Noddin, and further in view of Koontz, because DiStefano in view of Noddin, and further in view of Koontz does not teach or suggest each and every feature of claim 49. For example, DiStefano in view of Noddin, and further in view of Koontz does not teach or suggest "a complex power-signal (CPS) substructure that has passed an electrical performance acceptance test for at least one of an electrical integrity and electrical signal delay, and wherein the test for electrical integrity includes a test for at least one of an electrical short, an electrical open, and erroneous an impedance; a first dielectric-metallic (DM) laminate that includes an alternating sequence of an equal number N of dielectric layers and metallic layers such that a first dielectric layer of the N dielectric layers is formed on a first external surface of the CPS substructure,

wherein N is at least 2, and wherein a first multilevel conductive via through the first DM laminate is electrically coupled to a first metal layer of the CPS substructure", based on the same reasons presented *supra* in conjunction with claim 28.

In addition, DiStefano in view of Noddin does not teach or suggest "a second dielectric-metallic (DM) laminate that includes an alternating sequence of an equal number M of dielectric layers and metallic layers such that a first dielectric layer of the M dielectric layers is formed on a second external surface of the CPS substructure, wherein M is at least 2, and wherein a second multilevel conductive via through the second DM laminate is electrically coupled to a second metal layer of the CPS substructure", based on the same reasons presented *supra* in conjunction with claim 42.

Based on the preceding arguments, Applicants respectfully maintain that claim 49 is not unpatentable over DiStefano in view of Noddin, and further in view of Koontz, and that claim 49 is in condition for allowance.

**CONCLUSION**

Based on the preceding arguments, Applicants respectfully believe that all pending claims and the entire application meet the acceptance criteria for allowance and therefore request favorable action. If the Examiner believes that anything further would be helpful to place the application in better condition for allowance, Applicants invites the Examiner to contact Applicants' representative at the telephone number listed below.

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